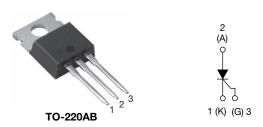
VS-10TTS08PbF, VS-10TTS08-M3

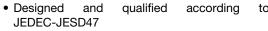
Vishay Semiconductors

Thyristor High Voltage, Phase Control SCR, 10 A



PRODUCT SUMMARY				
Package	TO-220AB			
Diode variation	Single SCR			
I _{T(AV)}	6.5 A			
V _{DRM} /V _{RRM}	800 V			
V_{TM}	1.15 V			
I _{GT}	15 mA			
TJ	- 40 °C to 125 °C			

FEATURES





• 125 °C max. operating junction temperature

Material categorization:
For definitions of compliance please see

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

www.vishay.com/doc?99912

 Typical usage is in input rectification crowbar (soft star) and AC switch in motor control, UPS, welding, and battery charge

DESCRIPTION

The VS-10TTS08... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS					
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS					
Capacitive input filter T _A = 55 °C, T _J = 125 °C, common heatsink of 1 °C/W	13.5	17	А		

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
I _{T(AV)}	Sinusoidal waveform	6.5	Α		
I _{T(RMS)}		10	A		
V _{RRM} /V _{DRM}		800	V		
I _{TSM}		110	А		
V _T	6.5 A, T _J = 25 °C	1.15	V		
dV/dt		150	V/µs		
dl/dt		100	A/µs		
T _J	Range	- 40 to 125	°C		

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA			
VS-10TTS08PbF, VS-10TTS08-M3	800	800	1.0			

VS-10TTS08PbF, VS-10TTS08-M3

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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average on-state current	I _{T(AV)}	T = 110 °C 190° conduc	ation half aina waya	6.5		
Maximum RMS on-state current	I _{T(RMS)}	T _C = 112 °C, 180° conduc	Clion riali sirie wave	10	Α	
Maximum peak, one-cycle,	1	10 ms sine pulse, rated V	_{RRM} applied, T _J = 125 °C	95	_ A	
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no volta	age reapplied, T _J = 125 °C	110		
Maximum 12t for fucing	l ² t	10 ms sine pulse, rated V	RRM applied, T _J = 125 °C	45	A ² s	
Maximum I ² t for fusing	1-1	10 ms sine pulse, no voltage reapplied, T _J = 125 °C		64	A ² S	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no vo	$t = 0.1$ ms to 10 ms, no voltage reapplied, $T_J = 125$ °C			
Maximum on-state voltage drop	V _{TM}	6.5 A, T _J = 25 °C		1.15	V	
On-state slope resistance	r _t	T 105 %C		17.3	mΩ	
Threshold voltage	V _{T(TO)}	T _J = 125 °C		0.85	V	
Maximum reverse and direct leakage	1 /1	T _J = 25 °C	V Detect V A/	0.05		
current	I _{RM} /I _{DM}	T _J = 125 °C	V_R = Rated V_{RRM}/V_{DRM}	1.0		
Typical holding current	I _H	Anode supply = 6 V, resistive load, initial I_T = 1 A, T_J = 25 °C		30	mA	
Maximum latching current	ΙL	Anode supply = 6 V, resistive load, T _J = 25 °C		50		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80$	0% , $V_{DRM} = R_g - k = Open$	150	V/µs	
Maximum rate of rise of turned-on current	dl/dt			100	A/μs	

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P _{GM}		8.0	w	
Maximum average gate power	P _{G(AV)}		2.0	VV	
Maximum peak positive gate current	+I _{GM}		1.5	Α	
Maximum peak negative gate voltage	-V _{GM}		10	V	
	I _{GT}	Anode supply = 6 V, resistive load, T _J = - 65 °C	20		
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T _J = 25 °C	15	mA	
		Anode supply = 6 V, resistive load, T _J = 125 °C	10		
Marrian was reliand DC and		Anode supply = 6 V, resistive load, T _J = - 65 °C	1.2		
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	1	.,,	
voltage to trigger		Anode supply = 6 V, resistive load, T _J = 125 °C	0.7	V	
Maximum DC gate voltage not to trigger	V_{GD}	T _J = 125 °C, V _{DRM} = Rated value	0.2		
Maximum DC gate current not to trigger	I_{GD}	ij = 125 C, v _{DRM} = nated value	0.1	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t _{gt}	T _J = 25 °C	0.8	
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	3	μs
Typical turn-off time	t _q	1J = 125 C	100	



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THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		- 40 to 125	°C	
Maximum thermal resistance, junction to case		R _{thJC}	DC operation	1.5		
Maximum thermal resistance, junction to ambient		R _{thJA}		62	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.5		
Approximate weight				2	g	
Approximate weight				0.07	oz.	
Mounting torque -	minimum			6 (5)	kgf · cm	
	maximum			12 (10)	(lbf · in)	
Marking device			Case style TO-220AB	10TT:	S08	

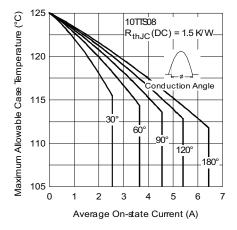


Fig. 1 - Current Rating Characteristics

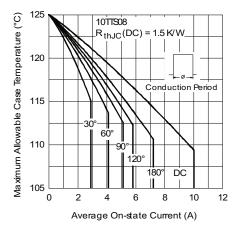


Fig. 2 - Current Rating Characteristic

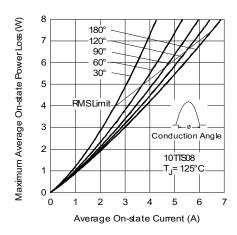


Fig. 3 - On-State Power Loss Characteristics

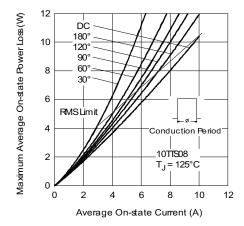


Fig. 4 - On-State Power Loss Characteristics

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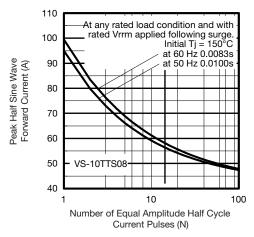


Fig. 5 - Maximum Non-Repetitive Surge Current

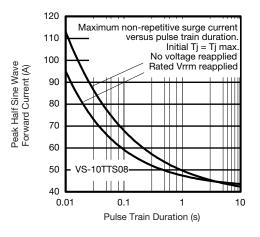


Fig. 6 - Maximum Non-Repetitive Surge Current

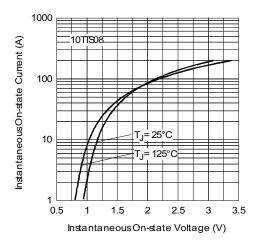


Fig. 7 - On-State Voltage Drop Characteristics

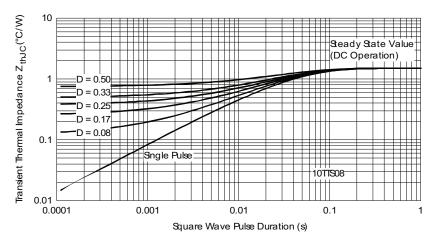


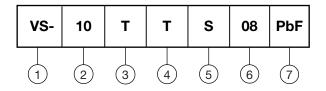
Fig. 8 - Thermal Impedance ZthJC Characteristics

VS-10TTS08PbF, VS-10TTS08-M3

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating

3 - Circuit configuration:

T = Single thyristor

4 - Package:

T = TO-220AB

5 - Type of silicon:

S = Converter grade

6 - Voltage code x 100 = V_{RRM}

7 - Environmental digit:

PbF = Lead (Pb)-free and RoHS compliant

-M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION					
VS-10TTS08PbF	50	1000	Antistatic plastic tubes		
VS-10TTS08-M3	50	1000	Antistatic plastic tubes		

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95222</u>				
Part marking information	TO-220AB PbF	www.vishay.com/doc?95225		
Part marking information	TO-220AB -M3	www.vishay.com/doc?95028		



Vishay Semiconductors

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

- 1. Anode/open
- 2. Cathode
- 3. Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIMETERS		INCHES		NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

SYMBOL	MILLIM	IETERS	INC	INCHES		
STIMBOL	MIN.	MAX.	. MIN. MAX.		NOTES	
E	10.11	10.51	0.398	0.414	3, 6	
E1	6.86	8.89	0.270	0.350	6	
E2	-	0.76	-	0.030	7	
е	2.41	2.67	0.095	0.105		
e1	4.88	5.28	0.192	0.208		
H1	6.09	6.48	0.240	0.255	6, 7	
L	13.52	14.02	0.532	0.552		
L1	3.32	3.82	0.131	0.150	2	
ØΡ	3.54	3.73	0.139	0.147		
Q	2.60	3.00	0.102	0.118		
θ	90° to 93°		90° t	o 93°		
		•	•	•		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

Lead tip



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Vishay

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